

**TECHNOLOGY TRANSFER OFFICE** 

**AVAILABLE TECHNOLOGIES** 

**CONTACT US** 

**Request Information** 

Permalink

# Silicon Based Chirped Grating Emitter for Uniform Power Emission

Tech ID: 29034 / UC Case 2017-566-0

#### **ABSTRACT**

Researchers at the University of California, Davis, have developed a chirped grating emitter with ultra-sharp instantaneous field of view (IFOV) for optical beam-steering applications.

# **FULL DESCRIPTION**

Optical phased arrays (OPAs) are attractive due to their numerous optical beam-steering applications including: free-space optical interconnect, sensing, data communication and light detection and ranging. Current OPAs, however, lack efficient transfer of energy and a uniform direction and mode of light travel (emission/coupling and propagation) that is required for the longer wavelengths of light used in such beam-steering applications. One way to reduce the surface emission rate is to employ shallow etch depths on silicon but the fabrication of gratings is very difficult.

Researchers at the University of California, Davis, have developed a silicon based OPA platform for far-field pattern beam-steering applications. The platform produces an ultra-sharp IFOV and a uniform emission intensity profile up to 8 mm in length. The platform has been successfully tested to be able to modulate emission rates for a combination of duty cycles with custom grating widths while maintaining a clear far field pattern and uniform power emission over 1 mm length. By integrating silicon with lower refractive index silicon nitride (Si3N4), silicon-dioxide (SiO2) and blazed grating fabrication techniques, the platform produces a narrow beam that does not introduce side lobes and can be used to filter emissions from undesired polarization rotations for top emission efficiency.

# **APPLICATIONS**

- ▶ Beam steering applications such as:
- ▶ Free-space optical interconnect
- Sensing
- ▶ Data communication
- ▶ Light detection and ranging
- ▶ Optical multi-tiling of several smaller IFOVs to form high-resolution wide IFOVs

# **FEATURES/BENEFITS**

- ▶ Designed for uniform power emission over 8 mm length
- ► Can modulate emission rate while maintaining the propagation constant
- ► Compatible for large scale integration and packaging
- ► Longer coupling lengths
- ► Low propagation loss

# **PATENT STATUS**

Country	Туре	Number	Dated	Case
United States Of America	Issued Patent	10,429,588	10/01/2019	2017-566

# **RELATED MATERIALS**

► Kuanping Shang, Chuan Qin, Yu Zhang, Guangyao Liu, Xian Xiao, Shaoqi Feng, and S.J. B. Yoo, "Uniform emission, constant wavevector silicon grating surface emitter for beam steering with ultra-sharp instantaneous field-of-view,"

Opt. Express 25, 19655-19661 (2017) - 08/21/2017

#### CONTACT

Michael M. Mueller mmmueller@ucdavis.edu tel: .



### **INVENTORS**

- ▶ Shang, Kuanping
- ► Yoo, S.J. Ben
- ▶ Zhang, Yu

# OTHER INFORMATION

# **KEYWORDS**

grating emitter, silicon,
silicon nitride, silicon
dioxide, optics, field of
view, optical phased
arrays, wavevector, surface
emission, beam-steering,
power, energy, tiling, multitiling, Si3N4, SiO2, Si,
OPA, IFOV

# **CATEGORIZED AS**

# Optics and

# **Photonics**

► All Optics and Photonics

- **▶** Communications
  - Networking
  - ▶ Optical
- ▶ Nanotechnology
  - ▶ Electronics

# **RELATED CASES**

2017-566-0

## **ADDITIONAL TECHNOLOGIES BY THESE INVENTORS**

- ▶ Higher-Speed and More Energy-Efficient Signal Processing Platform for Neural Networks
- ► Crystal Orientation Optimized Optical Frequency Shifter
- ► Hyperspectral Compressive Imaging
- ▶ Multi-Wavelength, Nanophotonic, Neural Computing System
- ► Athermal Nanophotonic Lasers
- ▶ Ultra-High Resolution Multi-Platform Heterodyne Optical Imaging
- ▶ Multi-Wavelength, Laser Array
- ▶ Optical Interposers for Embedded Photonics Integration
- ▶ Ultrahigh-Bandwidth Low-Latency Reconfigurable Memory Interconnects by Wavelength Routing
- ▶ Development of a CMOS-Compatible, Nano-photonic, Laser
- ▶ Energy Efficient and Scalable Reconfigurable All-to-All Switching Architecture
- ► Compressive High-Speed Optical Transceiver
- ► All-Optical Regenerators
- ► Tensorized Optical Neural Network Architecture
- ► Energy-Efficient All-Optical Nanophotonic Computing
- ▶ 3D Photonic and Electronic Neuromorphic Artificial Intelligence

University of California, Davis **Technology Transfer Office** 1850 Research Park Drive, Suite 100, , Davis,CA 95618

Tel: 530.754.8649 techtransfer@ucdavis.edu https://research.ucdavis.edu/technologytransfer/

Fax: 530.754.7620

© 2017 - 2019, The Regents of the University of California Terms of use

**Privacy Notice**